



# Product Change Notification

**Change Notification #: 116312 - 00**

**Change Title: Intel® Pentium® Silver Processor N5000,  
Intel® Celeron® Processor N4100,  
Intel® Celeron® Processor N4000,  
Intel® Pentium® Silver Processor J5005,  
Intel® Celeron® Processor J4105,  
Intel® Celeron® Processor J4005,  
PCN 116312-00,  
Manufacturing Site,  
Vietnam will now provide Assembly in addition  
to previous announcements for Test and Finish**

**Date of Publication: June 28, 2018**

## Key Characteristics of the Change:

Manufacturing Site

## Forecasted Key Milestones:

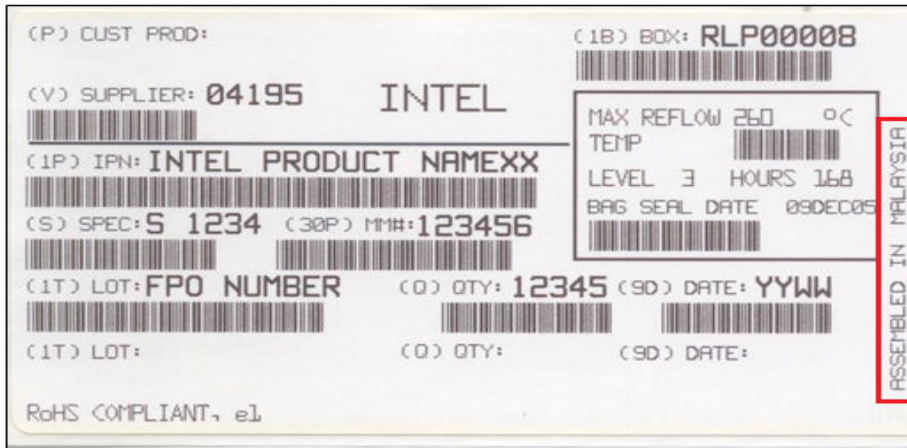
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	June 28, 2018
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## Description of Change to the Customer:

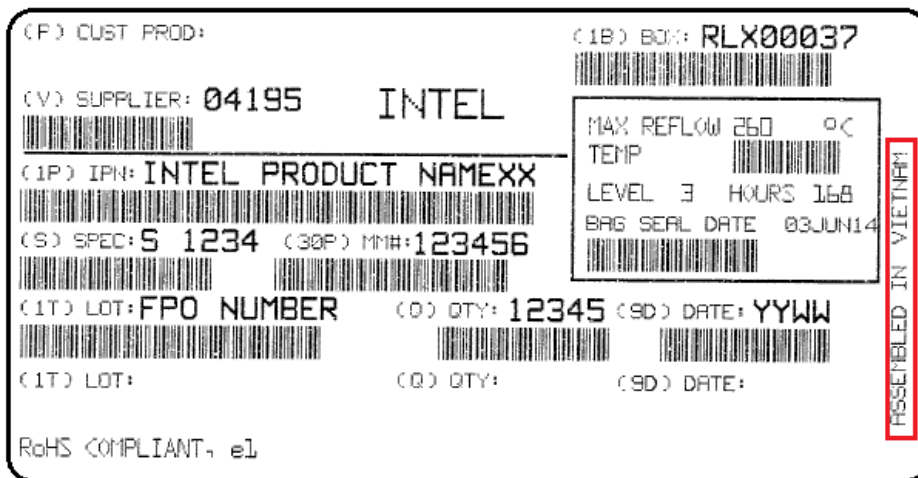
In order to ensure a continuous supply of the Intel® Pentium® Silver and Intel® Celeron® Processors listed in the "Products Affected" Table below, Intel announced in April 2018 that Vietnam would be a second Test/Finish Manufacturing site ([see additional PCN116173-01 record below](#)).

Today, Intel wants customers to take note that Vietnam is now certified to perform the **Assembly** of products as well. Therefore, full flow manufacturing [Assembly, Test and Finish] can now be done in either Malaysia or Vietnam. Vietnam has been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

If the Country of Origin (COO) identification is marked on the product, the box label will now display MALAY.



If the Country of Origin (COO) identification is marked on the product, the box label will now display Vietnam.



### Customer Impact of Change and Recommended Action:

The label value for products assembled in Vietnam will reflect the Vietnam Country Code as per the pictures above. Likewise, if products are assembled in Malaysia, they would see the Malaysia Country Code value.

Customers may contact their Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geo with questions.

Vietnam as an Assembly/Test/Finish HVM sites is now a qualified site, following Intel's Copy Exact (CE!) methodology. Copy Exactly! Methodology enables delivery of product from multiple production sites, which operate as a virtual factory that performs consistently and independent of the manufacturing source site. Additional benefits include faster production ramps that improve product availability and improved consistency to quality performance.

## Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Intel® Celeron® Processor J4005	B0	FH8068003067416	S R3S5	961644
Intel® Celeron® Processor J4105	B0	FH8068003067403	S R3S4	961643
Intel® Celeron® Processor N4000	B0	FH8068003067417	S R3S1	961640
Intel® Celeron® Processor N4100	B0	FH8068003067408	S R3S0	961639
Intel® Pentium® Silver Processor J5005	B0	FH8068003067415	S R3S3	961642
Intel® Pentium® Silver Processor N5000	B0	FH8068003067406	S R3RZ	961638

## PCN Revision History:

**Date of Revision:**

June 28, 2018

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 116312 - 00

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# Product Change Notification

**Change Notification #:** **116173 - 01**

**Change Title:** Intel® Celeron® Processor J4005,  
Intel® Celeron® Processor J4105,  
Intel® Celeron® Processor N4000,  
Intel® Celeron® Processor N4100,  
Intel® Pentium® Silver Processor J5005,  
Intel® Pentium® Silver Processor N5000,  
**PCN 116173-01, Manufacturing Site,  
Notification to Customers that Products  
Assembled in Malaysia, may now be Finished in  
either Malaysia and/or Vietnam**

**Reason for Revision: Pulling in milestone date**

**Date of Publication:** **April 18, 2018**

## Key Characteristics of the Change:

Manufacturing Site

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	<b>May 11, 2018</b>
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## Description of Change to the Customer:

### Reason for Revision: Pulling in milestone date due to customer demand

In order to ensure a continuous supply of the Intel® Pentium® Silver and Intel® Celeron® Processors listed in the "Products Affected" Table below, Intel will be adding a second Test/Finish Manufacturing site (Vietnam) to complete Test/Finish of products and ship to customers.

While Assembly and Test will be done in Malaysia, Intel's manufacturing site in Vietnam will help perform Test and Finish portions of manufacturing. Vietnam has been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

## Customer Impact of Change and Recommended Action:

Customers should notify their receiving department of the additional country which will be providing the Test/Finish on the products. It is possible that Customers may receive a mix of material from both sites. Customers may contact their Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geo with questions.

The Tested/Finished HVM sites are qualified sites, following Intel's Copy Exact (CE!) methodology. Copy Exactly! enables delivery of product from multiple production sites, which operate as a virtual factory that performs consistently and independent of the manufacturing source site. Additional benefits include faster production ramps that improve product availability and improved consistency to quality performance.

## Products Affected / Intel Ordering Codes:

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## PCN Revision History:

**Date of Revision:**

April 4, 2018

[April 18, 2018](#)**Revision Number:**

00

[01](#)**Reason:**

Originally Published PCN

[Pulling in milestone date](#)



# Product Change Notification

## 116173 - 01

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